

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT5720419

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	KENJI TAKAO	09/09/2019
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<b>Name:</b>	MITSUBISHI HEAVY INDUSTRIES, LTD.	
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<b>State/Country:</b>	JAPAN	
<b>Postal Code:</b>	100-8332	
<b>PROPERTY NUMBERS Total: 1</b>		
	<b>Property Type</b>	<b>Number</b>
	Application Number:	16494456
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<b>ATTORNEY DOCKET NUMBER:</b>	2019-1591A	
<b>NAME OF SUBMITTER:</b>	JANAE GALLUN	
<b>SIGNATURE:</b>	/Janae Gallun/	
<b>DATE SIGNED:</b>	09/16/2019	
<b>Total Attachments: 2</b>		
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Wenderoth, Lind & Ponack, LLP  
Attorney Docket No.: \_\_\_\_\_

<b>COMBINED DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN APPLICATION</b>	
<b>Title of Invention</b>	PLANT MONITORING SYSTEM, PLANT OPERATION ASSISTANCE SYSTEM, PLANT MONITORING METHOD, AND PROGRAM
<b>DECLARATION</b>	
As the below named inventor, I hereby declare that:	
This declaration is directed to: <input type="checkbox"/> The attached application, or	
<input checked="" type="checkbox"/> United States application or PCT international application	
number <u>PCT/JP2018/013226</u> filed on <u>March 29, 2018</u> .	
The above-identified application was made or authorized to be made by me.	
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.	
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.	
Note to Inventor: 37 C.F.R. § 1.63(c) states: "A person may not execute an oath or declaration for an application unless that person has reviewed and understands the contents of the application, including the claims, and is aware of the duty to disclose to the Office all information known to the person to be material to patentability as defined in § 1.56."	
<b>ASSIGNMENT</b>	
In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid, I hereby sell and assign to	
<u>MITSUBISHI HEAVY INDUSTRIES, LTD.</u>	
(Name of Assignee)	
of <u>2-3, Marunouchi 3-Chome, Chiyoda-ku, Tokyo 100-8332 Japan</u>	
(Address of Assignee)	
(hereinafter designated as the Assignee) my entire right, title and interest for the United States as defined in 35 USC 100, for any invention set forth in the above-identified application.	
I agree to execute all papers necessary in connection with this application for patent in the USPTO for the invention, and any continuation, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.	
I agree to execute all papers necessary in connection with any post-grant proceeding which may occur in connection with this application or continuation, divisional or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such post-grant proceeding.	
I agree to execute all papers and documents and perform any act which may be necessary in connection with claims or	

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provisions of the International Convention for Protection of Industrial Property or similar agreements.

I agree to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

I hereby authorize and request the USPTO to issue any and all Letters Patents of the United States resulting from the application or any continuation, divisional or reissue applications thereof to the Assignee, as Assignee of my entire interest, and covenant that I have not executed, and will not execute, any agreement in conflict herewith.

Inventor (Legal Name): Kenji TAKAO

Signature: Kenji Takao

September 9, 2019

Date: \_\_\_\_\_

Note: Use an additional form for each additional inventor